







# SolidMatrix® Surface Mount Fuses HC Series (High Current), 1206 Size



#### **Clearing Time Characteristics:**

% of current rating	Clearing time at 25°C
100%	4 hours min.
350%	5 seconds max.

#### **Agency Approval:**

Recognized Under the Components Program of UL. File Number: E232989.

#### **Patents:**

Patent numbers "US6,602,766", "US7,268,661 B2", "ZL02114719.1", "ZL200410104280.7", "ZL201020551360.8", "ZL201010299185.2", "ZL201220030614.0",

"ZL201210020693.1".

#### Features:

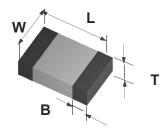
- High inrush current withstanding capability at high voltage
- Glass ceramic monolithic structure
- Sliver fusing element and silver termination with nickel and tin plating
- Superior arc suppression capability
- RoHS compliant and lead free materials
- Operating temperature range: -55°C to +150°C (with derating)

### **Shape and Dimensions:**

Unit	Inch	mm
L	0.126 ± 0.008	3.20 ± 0.20
W	$0.063 \pm 0.008$	1.60 ± 0.20
T1	0.038 ± 0.008	0.97 ± 0.20
T2	0.051 ± 0.008	1.30 ± 0.20
В	0.020 ± 0.010	0.51 ± 0.25

T1: Thickness for 10-25A:

T2: Thickness for 30-40A.



## **Ordering Information:**

Part Number	Current Rating (A)	Voltage Rating (VDC)	Interrupting Ratings	Nominal Cold DCR(Ω) <sup>1</sup>	Nominal I <sup>2</sup> t (A <sup>2</sup> s) <sup>2</sup>	Marking Code <sup>3</sup>
F1206HC10A0TM	10	35		0.0055	15	Q
F1206HC12A0TM	12	35	150A@35VDC	0.0045	20	Х
F1206HC15A0TM	15	35		0.0032	35	Y
F1206HC20A0TM	20	35		0.0023	80	Z
F1206HC25A0TM	25	35	200A@35VDC	0.0016	120	S
F1206HC30A0TM	30	35	200A@35VDC 300A@26VDC	0.0012	180	V
F1206HC40A0TM	40	35		0.0009	240	0

- Measured at ≤ 10% rated current and 25°C ambient.
  Melting I²t at 1000% of current rating.
  Blue Marking Character Code. Devices designed to be mounted with marking code facing up.

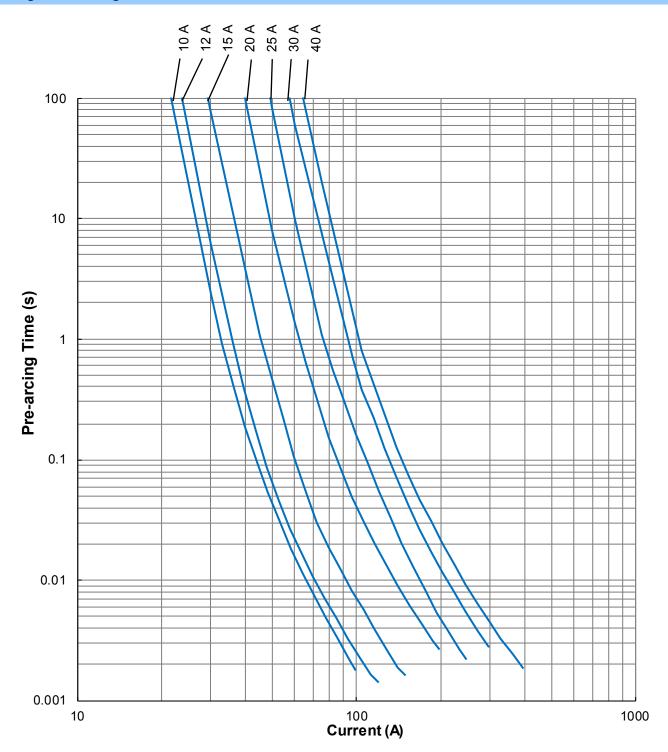






# SolidMatrix<sup>®</sup> Surface Mount Fuses HC Series (High Current), 1206 Size

# **Average Pre-arcing Time Curves:**



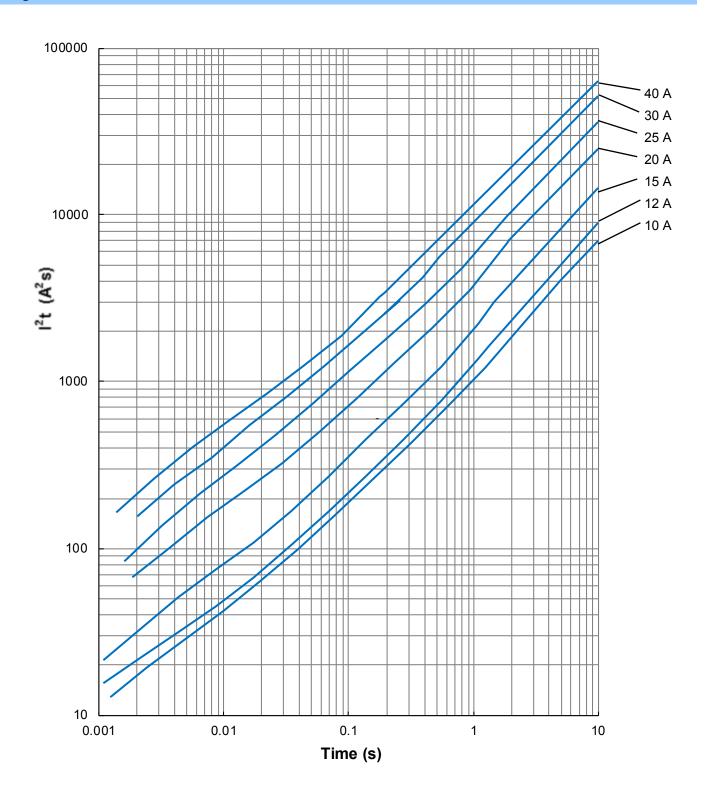






# SolidMatrix<sup>®</sup> Surface Mount Fuses HC Series (High Current), 1206 Size

# Average I<sup>2</sup>t vs. t Curves:











## SolidMatrix® Surface Mount Fuses

#### **Product Identification:**

F 0603 FA 1000 V032 T M

(1) (2) (3) (4) (5) (6) (7)

(1) Product Code: F—Chip Fuse

(2) Size Code: Standard EIA Chip Sizes

(3) Series Code: FA - Fast Acting, SB - Slow Blow,

HI - High Inrush, FF - Very Fast Acting, HB - High Current

(4) Current Rating Code: 1000 - 1000 mA (For HB, 10 - 10A)

(5) Voltage Rating Code: V032 - 32 VDC

(6) Package Code: T - Tape & Reel, B - Bulk

(7) Marking Code: M - With Marking

F 1206 HC 20A0 T M

(1) (2) (3) (4) (5) (6)

(1) Product Code: F-Chip Fuse

(2) Size Code: L x W (inch),

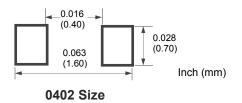
the first two digits-L (length), the last two digits-W (width)

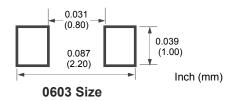
(3) Series Code: HC Series

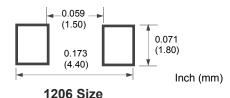
(4) Current Rating Code: 20A0—20.0A

(5) Package Code: T - Tape & Reel, B - Bulk

## **Recommended Land Pattern:**







### **Environmental Tests:**

No.	Test	Requirement	Test condition	Test reference
1	Soldering heat resistance	DCR change ≤ ±10% No mechanical damage	One dip at 260°C for 60 seconds	MIL-STD-202 Method 210
2	Solderability	Minimum 95% coverage	One dip at 245°C for 5 seconds	MIL-STD-202 Method 208
3	Thermal shock	DCR change ≤ ±10% No mechanical damage	100 cycles between -65°C and +125°C	MIL-STD-202 Method 107
4	Moisture resistance	DCR change ≤ ±15% No excessive corrosion	10 cycles	MIL-STD-202 Method 106
5	Salt spray	DCR change ≤ ±10% No excessive corrosion	48 hour exposure	MIL-STD-202 Method 101
6	Mechanical vibration	DCR change $\leq \pm 10\%$ No mechanical damage	0.4 " D.A. or 30 G between 5 – 3000 Hz	MIL-STD-202 Method 204
7	Mechanical shock	DCR change $\leq \pm 10\%$ No mechanical damage	1500 G, 0.5 ms, half-sine shocks	MIL-STD-202 Method 213
8	Life	No electrical "opens" during testing voltage drop change shall be less than $\pm 20\%$ of initial value	for 2000 hours at ambient temperature	Refer to AEM QIQ106









## SolidMatrix® Surface Mount Fuses

#### **Electrical Specification:**

#### Clearing Time Characteristics:

Same as specified on the Short Form Data Sheet

#### Insulation Resistance after Opening:

20,000 ohms typical when cleared with rated voltage applied. Fuse clearing under low voltage conditions may result in lower after clearing insulation resistance values. (Note: Under normal fault conditions (low or rated voltage conditions), AEM SolidMatrix fuses provide sufficient after clearing insulation resistance values for circuit protection.)

#### **Current Carrying Capacity:**

100% rated current at +25°C ambient for 4 hours minimum when evaluated per MIL-PRF-23419 Interrupt Ratings:

### **Fuse Selection and Temperature De-rating Guideline:**

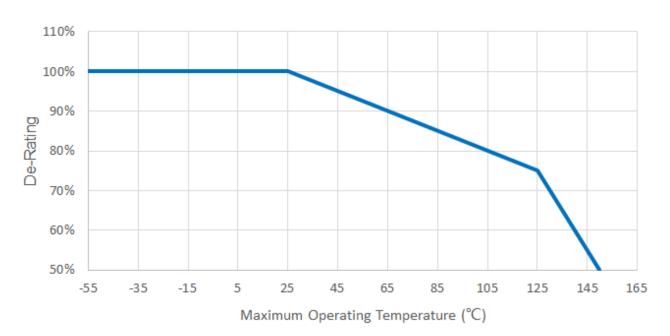
The ambient temperature affects the current carrying capacity of fuses. When a fuse is operating at a temperature higher than 25°C, the fuse shall be "de-rated".

To select a fuse from the catalog, the following rule may be followed:

Catalog Fuse Current Rating = Nominal Operating Current / 0.75 / % De-rating at the maximum operating temperature.

Example: At maximum operating temperature of 65°C, % De-rating is 90%. The nominal operating current is 4 A. The current rating for fuse selected from the catalog shall be: 4 / 0.75 / 90% = 5.9 or 6 A. Specifications and descriptions in this literature are as accurate as known at the time of publish, but are subject to change without notice.

# Temperature De-Rating Curve for SolidMatrix Fuses







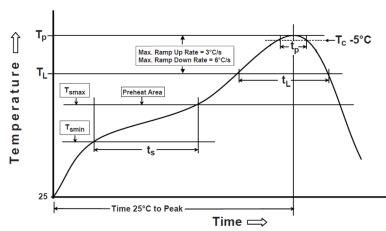




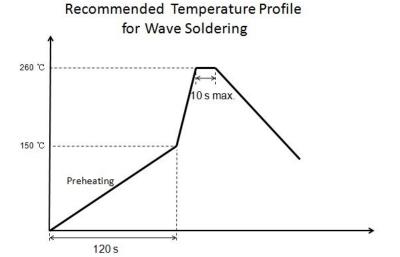
# SolidMatrix® Surface Mount Fuses

## **Soldering Temperature Profile:**

\* Recommended Temperature Profile for Reflow Soldering



\* Recommended Temperature Profile for Wave Soldering



Notice: Wave Soldering is suitable for 1206 and 0603 size.

#### **Pb-Free Profile Feature Assembly** Preheat/Soak Temperature Min (T<sub>smin</sub>) 150°C Temperature Max(T<sub>smax</sub>) 200°C Time( $t_s$ ) from ( $T_{smin}$ to $T_{smax}$ ) 60~120 seconds Ramp-uprate $(T_L to T_p)$ 3°C/second max. 217°C Liquidous temperature(T<sub>L</sub>) Time(t<sub>L</sub>) maintained above T<sub>L</sub> 60~150 seconds 260°C Peak package body temperature (Tp) Time (tp)\*within 5°C of the specified 30 seconds \* classification temperature (T<sub>c</sub>) Ramp-down rate $(T_p \text{ to } T_L)$ 6°C/second max. Time 25°C to peak temperature 8 minutes max.

## Packaging:

Chip Size	Parts on 7 inch (178 mm) Reel
0402 (1005)	10,000
0603 (1608)	4,000
0603FF (1608)	6,000
1206 (3216)	3,000

 $<sup>^{\</sup>star}$  Tolerance for peak profile temperature  $(T_{\textrm{p}})$  is defined as a supplier minimum and a user maximum





### **Disclaimer**

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